

### 2SJ529STL-E-VB Datasheet

# P-Channel 60-V (D-S) MOSFET

| PRODUCT SUMMARY     |                                    |                    |                      |  |  |
|---------------------|------------------------------------|--------------------|----------------------|--|--|
| V <sub>DS</sub> (V) | $R_{DS(on)}(\Omega)$               | I <sub>D</sub> (A) | Q <sub>g</sub> (Typ) |  |  |
| - 60                | 0.061 at V <sub>GS</sub> = - 10 V  | - 30               | 10                   |  |  |
| - 00                | 0.072 at V <sub>GS</sub> = - 4.5 V | - 25               | 10                   |  |  |

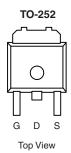
#### **FEATURES**

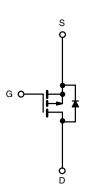
- TrenchFET® Power MOSFET
- 100 % UIS Tested

#### **APPLICATIONS**

Load Switch







P-Channel MOSFET

| ABSOLUTE MAXIMUM RATINGS $T_C = 2$                  | 25 °C, unless othe                | rwise noted     |                 |    |  |
|---|-----------------------------------|-----------------|-----------------|----|--|
| Parameter   | Symbol                            | Limit           | Unit            |    |  |
| Gate-Source Voltage                                 | V <sub>GS</sub>                   | ± 20            | V               |    |  |
| Continuous Drain Current (T <sub>.I</sub> = 175 °C) | T <sub>C</sub> = 25 °C            | I_              | - 30            |    |  |
| Continuous Drain Current (1) = 175 C)               | T <sub>C</sub> = 100 °C           | I <sub>D</sub>  | - 25            |    |  |
| Pulsed Drain Current                                | I <sub>DM</sub>                   | - 30            | Α               |    |  |
| Continuing Source Current (Diode Conduction)        | I <sub>S</sub>                    | - 20            |                 |    |  |
| Avalanche Current                                   | I <sub>AS</sub>                   | - 20            | 1               |    |  |
| Single Pulse Avalanche Energy                       | L = 0.1 mH                        | E <sub>AS</sub> | 7.2             | mJ |  |
| Maximum Power Dissipation                           | T <sub>C</sub> = 25 °C            | P <sub>D</sub>  | 34 <sup>a</sup> | w  |  |
| iviaximum rower dissipation                         | T <sub>A</sub> = 25 °C            | r D             | 4 <sup>b</sup>  | ¬  |  |
| Operating Junction and Storage Temperature Range    | T <sub>J</sub> , T <sub>stg</sub> | - 55 to 175     | °C              |    |  |

| THERMAL RESISTANCE RATINGS       |              |                   |         |         |      |  |
|----------------------------------|--------------|-------------------|---------|---------|------|--|
| Parameter                        |              | Symbol            | Typical | Maximum | Unit |  |
| hunghian ta Ambianto             | t ≤ 10 sec   | R <sub>thJA</sub> | 20      | 25      |      |  |
| Junction-to-Ambient <sup>D</sup> | Steady State |                   | 62      | 75      | °C/W |  |
| Junction-to-Case                 |              | R <sub>thJC</sub> | 5       | 6       |      |  |

#### Notes:

- a. See SOA curve for voltage derating.
- b. Surface Mounted on 1" x 1" FR-4 boad.

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| Parameter   | Symbol              | Test Conditions   | Min   | Typ <sup>a</sup> | Max   | Unit |  |
|---|---------------------|---|-------|------------------|-------|------|--|
| Static  |                     |   |       |                  |       |      |  |
| Orain-Source Breakdown Voltage V <sub>(BR)DSS</sub> |                     | V <sub>GS</sub> = 0 V, I <sub>D</sub> = - 250 μA - 60                     |       |                  |       | V    |  |
| Gate Threshold Voltage                              | V <sub>GS(th)</sub> | $V_{DS} = V_{GS}, I_{D} = -250 \mu A$                                     | - 1.0 | - 2.0            | - 3.0 | _ v  |  |
| Gate-Body Leakage                                   | I <sub>GSS</sub>    | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$                         |       |                  | ± 100 | nA   |  |
|   |                     | V <sub>DS</sub> = - 60 V, V <sub>GS</sub> = 0 V                           |       |                  | - 1   |      |  |
| Zero Gate Voltage Drain Current                     | I <sub>DSS</sub>    | V <sub>DS</sub> = - 60 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C  |       |                  | - 50  | μΑ   |  |
|   |                     | V <sub>DS</sub> = - 60 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 175 °C  |       |                  | - 150 |      |  |
| On-State Drain Current <sup>b</sup>                 | I <sub>D(on)</sub>  | V <sub>DS</sub> = - 5 V, V <sub>GS</sub> = - 10 V                         | - 10  |                  |       | Α    |  |
|   |                     | V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 5 A                          | 0.061 |                  |       |      |  |
| 5 h   | _                   | V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 5 A, T <sub>J</sub> = 125 °C |       | 0.100            |       | Ω    |  |
| Drain-Source On-State Resistance <sup>b</sup>       | r <sub>DS(on)</sub> | V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 5 A, T <sub>J</sub> = 175 °C |       | 0.150            |       |      |  |
|   |                     | V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 2 A                         |       | 0.072            |       |      |  |
| Forward Transconductance <sup>b</sup>               | 9 <sub>fs</sub>     | V <sub>DS</sub> = - 15 V, I <sub>D</sub> = - 5 A                          |       | 8                |       | S    |  |
| Dynamic   | •                   |   |       | •                |       |      |  |
| Input Capacitance                                   | C <sub>iss</sub>    |   |       | 1000             |       | pF   |  |
| Output Capacitance                                  | C <sub>oss</sub>    | $V_{DS} = -25 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$         |       | 120              |       |      |  |
| Reverse Transfer Capacitance                        | C <sub>rss</sub>    |   |       | 100              |       |      |  |
| Total Gate Charge                                   | $Q_g$               |   |       | 10               |       | nC   |  |
| Gate-Source Charge                                  | Q <sub>gs</sub>     | $V_{DS} = -30 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -8.4 \text{ A}$  |       | 2.1              |       |      |  |
| Gate-Drain Charge                                   | Q <sub>gd</sub>     |   |       | 3.2              |       |      |  |
| Gate Resistance                                     | $R_{g}$             | f = 1 MHz   | 8.0   |                  |       | Ω    |  |
| Turn-On Delay Time <sup>c</sup>                     | t <sub>d(on)</sub>  |   |       | 6                |       |      |  |
| Rise Time <sup>c</sup>                              | t <sub>r</sub>      | $V_{DD} = -30 \text{ V}, R_L = 3.57 \Omega$                               |       | 15               |       | 20   |  |
| Turn-Off Delay Time <sup>c</sup>                    | t <sub>d(off)</sub> | $I_D \cong$ - 8.4 A, $V_{GEN} =$ - 10 V, $R_G = 2.5 \Omega$               |       | 16               |       | ns   |  |
| Fall Time <sup>c</sup>                              | t <sub>f</sub>      | 1   |       | 8                |       |      |  |
| Source-Drain Diode Ratings and Cha                  | aracteristics       | (T <sub>C</sub> = 25 °C) <sup>b</sup>                                     |       |                  |       |      |  |
| Pulsed Current                                      | I <sub>SM</sub>     |   |       |                  | - 30  | Α    |  |
| Forward Voltage <sup>b</sup>                        | $V_{SD}$            | I <sub>F</sub> = -2 A, V <sub>GS</sub> = 0 V - 0.9 - 1                    |       | - 1.3            | V     |      |  |
| Reverse Recovery Time                               | t <sub>rr</sub>     | L = 9 A di/dt = 100 A/::2   |       | 50               |       | ns   |  |
| Reverse Recovery Time                               | Q <sub>rr</sub>     | I <sub>F</sub> = - 8 A, di/dt = 100 A/μs                                  |       | 80               |       | nC   |  |

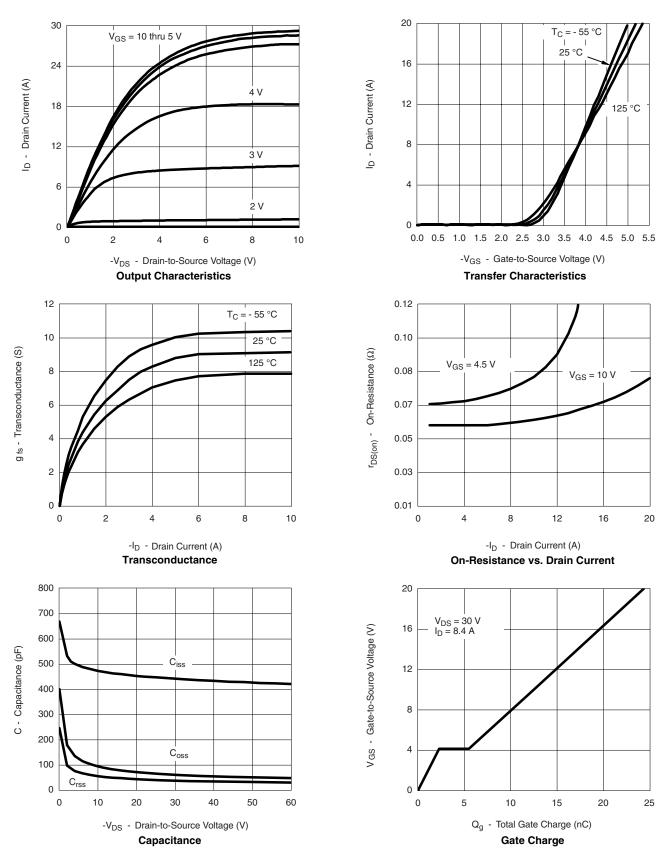
#### Notes:

- a. Guaranteed by design, not subject to production testing.
- b. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

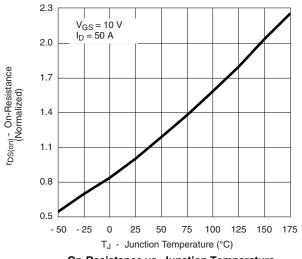


#### TYPICAL CHARACTERISTICS 25 °C unless noted

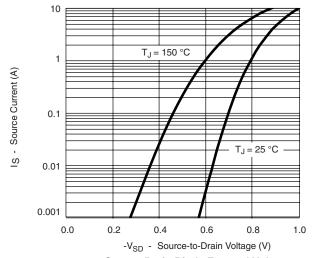




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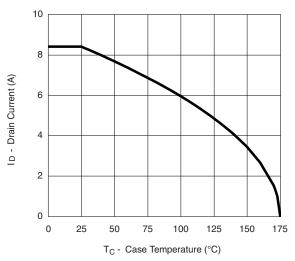




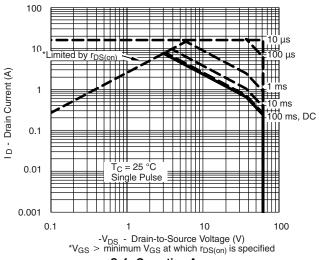


Source-Drain Diode Forward Voltage

#### THERMAL RATINGS



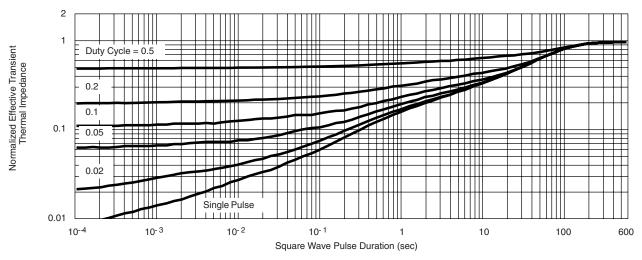
**Drain Current vs. Case Temperature** 



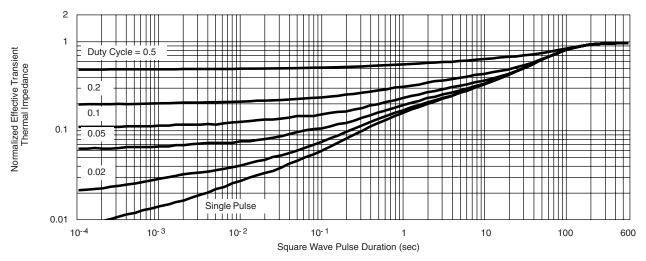
Safe Operating Area



#### THERMAL RATINGS



Normalized Thermal Transient Impedance, Junction-to-Ambient

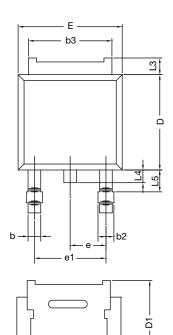


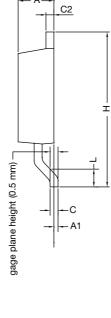
Normalized Thermal Transient Impedance, Junction-to-Case

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## **TO-252AA CASE OUTLINE**





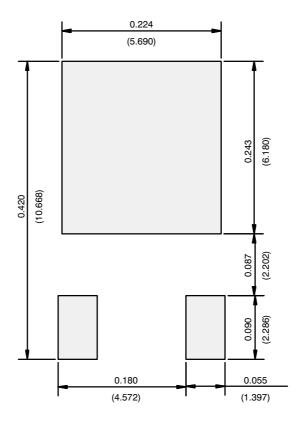
|  | MILLIMETERS |       | INCHES    |       |  |
|--|-------------|-------|-----------|-------|--|
| DIM.   | MIN.        | MAX.  | MIN.      | MAX.  |  |
| Α  | 2.18        | 2.38  | 0.086     | 0.094 |  |
| A1   | -           | 0.127 | -         | 0.005 |  |
| b  | 0.64        | 0.88  | 0.025     | 0.035 |  |
| b2   | 0.76        | 1.14  | 0.030     | 0.045 |  |
| b3   | 4.95        | 5.46  | 0.195     | 0.215 |  |
| С  | 0.46        | 0.61  | 0.018     | 0.024 |  |
| C2   | 0.46        | 0.89  | 0.018     | 0.035 |  |
| D  | 5.97        | 6.22  | 0.235     | 0.245 |  |
| D1   | 5.21        | -     | 0.205     | -     |  |
| E  | 6.35        | 6.73  | 0.250     | 0.265 |  |
| E1   | 4.32        | -     | 0.170     | -     |  |
| Н  | 9.40        | 10.41 | 0.370     | 0.410 |  |
| е  | 2.28        | BSC   | 0.090 BSC |       |  |
| e1   | 4.56        | BSC   | 0.180 BSC |       |  |
| L  | 1.40        | 1.78  | 0.055     | 0.070 |  |
| L3   | 0.89        | 1.27  | 0.035     | 0.050 |  |
| L4   | -           | 1.02  | -         | 0.040 |  |
| L5   | 1.14        | 1.52  | 0.045     | 0.060 |  |
| ECN: X12-0247-Rev. M, 24-Dec-12<br>DWG: 5347 |             |       |           |       |  |

#### Note

• Dimension L3 is for reference only.



### **RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)**



Recommended Minimum Pads Dimensions in Inches/(mm)



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